Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	18
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 17x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package	20-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f15345t-i-so

TABLE 4-2: MEMORY ACCESS PARTITION

<table>
<tr><th rowspan="2">REG</th><th rowspan="2">Address</th><th colspan="4">Partition</th></tr>
<tr><th>$\overline{\text{BBEN}}$ = 1
SAFEN = 1</th><th>$\overline{\text{BBEN}}$ = 1
SAFEN = 0</th><th>$\overline{\text{BBEN}}$ = 0
SAFEN = 1</th><th>$\overline{\text{BBEN}}$ = 0
SAFEN = 0</th></tr>
<tr><td rowspan="3">PFM</td><td>00 0000h
• • •
Last Boot Block Memory Address</td><td rowspan="3">APPLICATION BLOCK(4)</td><td rowspan="2">APPLICATION BLOCK(4)</td><td>BOOT BLOCK(4)</td><td>BOOT BLOCK(4)</td></tr>
<tr><td>Last Boot Block Memory Address + 1(1)
• • •
Last Program Memory Address - 80h</td><td rowspan="2">APPLICATION BLOCK(4)</td><td>APPLICATION BLOCK(4)</td></tr>
<tr><td>Last Program Memory Address - 7Fh(2)
• • •
Last Program Memory Address</td><td>SAF(4)</td><td>SAF(4)</td></tr>
<tr><td>CONF IG</td><td>Config Memory Address(3)</td><td colspan="4">CONFIG</td></tr>
</table>

Note 1: Last Boot Block Memory Address is based on BBSIZE<2:0> given in Table 5-1.

2: Last Program Memory Address is the Flash size given in Table 4-1.

3: Config Memory Address are the address locations of the Configuration Words given in Table 13-2.

4: Each memory block has a corresponding write protection fuse defined by the $\overline{\text{WRTAPP}}$, $\overline{\text{WRTB}}$ and $\overline{\text{WRTC}}$ bits in the Configuration Word (Register 5-4).

5.2 Register Definitions: Configuration Words

REGISTER 5-1: CONFIGURATION WORD 1: OSCILLATORS

R/P-1	U-1	R/P-1	U-1	U-1	R/P-1
FCMEN	—	CSWEN	—	—	$\overline{\text{CLKOUTEN}}$
bit 13					bit 8

U-1	R/P-1	R/P-1	R/P-1	U-1	R/P-1	R/P-1	R/P-1
—	RSTOSC2	RSTOSC1	RSTOSC0	—	FEXTOSC2	FEXTOSC1	FEXTOSC0
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	x = Bit is unknown	U = Unimplemented bit, read as ‘1’
‘0’ = Bit is cleared	‘1’ = Bit is set	W = Writable bit	n = Value when blank or after Bulk Erase

bit 13 **FCMEN**: Fail-Safe Clock Monitor Enable bit
1 = FSCM timer enabled
0 = FSCM timer disabled

bit 12 **Unimplemented**: Read as ‘1’

bit 11 **CSWEN**: Clock Switch Enable bit
1 = Writing to NOSC and NDIV is allowed
0 = The NOSC and NDIV bits cannot be changed by user software

bit 10-9 **Unimplemented**: Read as ‘1’

bit 8 **$\overline{\text{CLKOUTEN}}$**: Clock Out Enable bit
If FEXTOSC = EC (high, mid or low) or Not Enabled:
1 = CLKOUT function is disabled; I/O or oscillator function on OSC2
0 = CLKOUT function is enabled; FOSC/4 clock appears at OSC2
Otherwise:
This bit is ignored.

bit 7 **Unimplemented**: Read as ‘1’

bit 6-4 **RSTOSC<2:0>**: Power-up Default Value for COSC bits
This value is the Reset-default value for COSC and selects the oscillator first used by user software.
111 = EXTOSC operating per FEXTOSC bits (device manufacturing default)
110 = HFINTOSC with HFFRQ = 3’b010
101 = LFINTOSC
100 = SOSC
011 = Reserved
010 = EXTOSC with 4x PLL, with EXTOSC operating per FEXTOSC bits
001 = EXTOSC with 2x PLL, with EXTOSC operating per FEXTOSC bits
000 = HFINTOSC with CDIV = 1:1 and HFFRQ = 3’b110

bit 3 **Unimplemented**: Read as ‘1’

bit 2-0 **FEXTOSC<2:0>**:FEXTOSC External Oscillator Mode Selection bits
111 = EC (External Clock) above 8 MHz; PFM set to high power (device manufacturing default)
110 = EC (External Clock) for 100 kHz to 8 MHz; PFM set to medium power
101 = EC (External Clock) below 100 kHz
100 = Oscillator not enabled
011 = Reserved (do not use)
010 = HS (Crystal oscillator) above 4 MHz; PFM set to high power
001 = XT (Crystal oscillator) above 100 kHz, below 4 MHz; PFM set to medium power
000 = LP (Crystal oscillator) optimized for 32.768 kHz; PFM set to low power

5.3 Code Protection

Code protection allows the device to be protected from unauthorized access. Program memory protection and data memory are controlled independently. Internal access to the program memory is unaffected by any code protection setting.

5.3.1 PROGRAM MEMORY PROTECTION

The entire program memory space is protected from external reads and writes by the $\overline{\text{CP}}$ bit in Configuration Words. When $\overline{\text{CP}}$ = `0`, external reads and writes of program memory are inhibited and a read will return all '`0`'s. The CPU can continue to read program memory, regardless of the protection bit settings. Self-writing the program memory is dependent upon the write protection setting. See **Section 5.4 "Write Protection"** for more information.

5.4 Write Protection

Write protection allows the device to be protected from unintended self-writes. Applications, such as boot loader software, can be protected while allowing other regions of the program memory to be modified.

The $\overline{\text{WRTAPP}}$, $\overline{\text{WRTSAF}}$, $\overline{\text{WRTB}}$, $\overline{\text{WRTC}}$ bits in Configuration Words (Register 5-4) define whether the corresponding region of the program memory block is protected or not.

5.5 User ID

Four memory locations (8000h-8003h) are designated as ID locations where the user can store checksum or other code identification numbers. These locations are readable and writable during normal execution. See **Section 13.3.6 "NVMREG Access to Device Information Area, Device Configuration Area, User ID, Device ID and Configuration Words"** for more information on accessing these memory locations. For more information on checksum calculation, see the *"*PIC16(L)F153xx *Memory Programming Specification"* (DS40001838).

REGISTER 17-7: IOCCP: INTERRUPT-ON-CHANGE PORTC POSITIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCCP7(1)	IOCCP6(1)	IOCCP5	IOCCP4	IOCCP3	IOCCP2	IOCCP1	IOCCP0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **IOCCP<7:0>:** Interrupt-on-Change PORTC Positive Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a positive-going edge. IOCCFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

REGISTER 17-8: IOCCN: INTERRUPT-ON-CHANGE PORTC NEGATIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCCN7(1)	IOCCN6(1)	IOCCN5	IOCCN4	IOCCN3	IOCCN2	IOCCN1	IOCCN0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **IOCCN<7:0>:** Interrupt-on-Change PORTC Negative Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a negative-going edge. IOCCFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

REGISTER 17-9: IOCCF: INTERRUPT-ON-CHANGE PORTC FLAG REGISTER

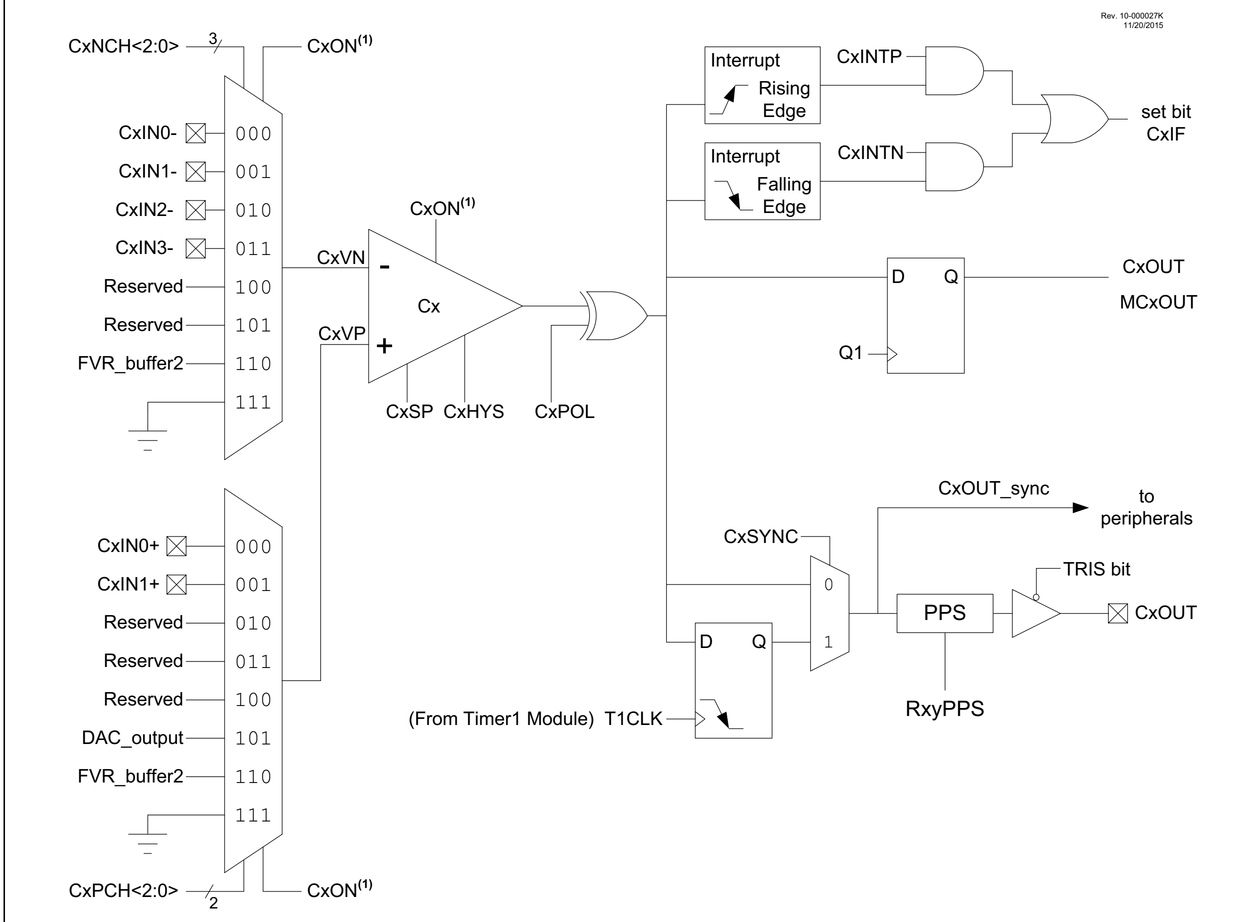
R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0
IOCCF7(1)	IOCCF6(1)	IOCCF5	IOCCF4	IOCCF3	IOCCF2	IOCCF1	IOCCF0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS - Bit is set in hardware

bit 7-0 **IOCCF<7:0>:** Interrupt-on-Change PORTC Flag bits
1 = An enabled change was detected on the associated pin
Set when IOCCPx = 1 and a rising edge was detected on RCx, or when IOCCNx = 1 and a falling edge was detected on RCx.
0 = No change was detected, or the user cleared the detected change

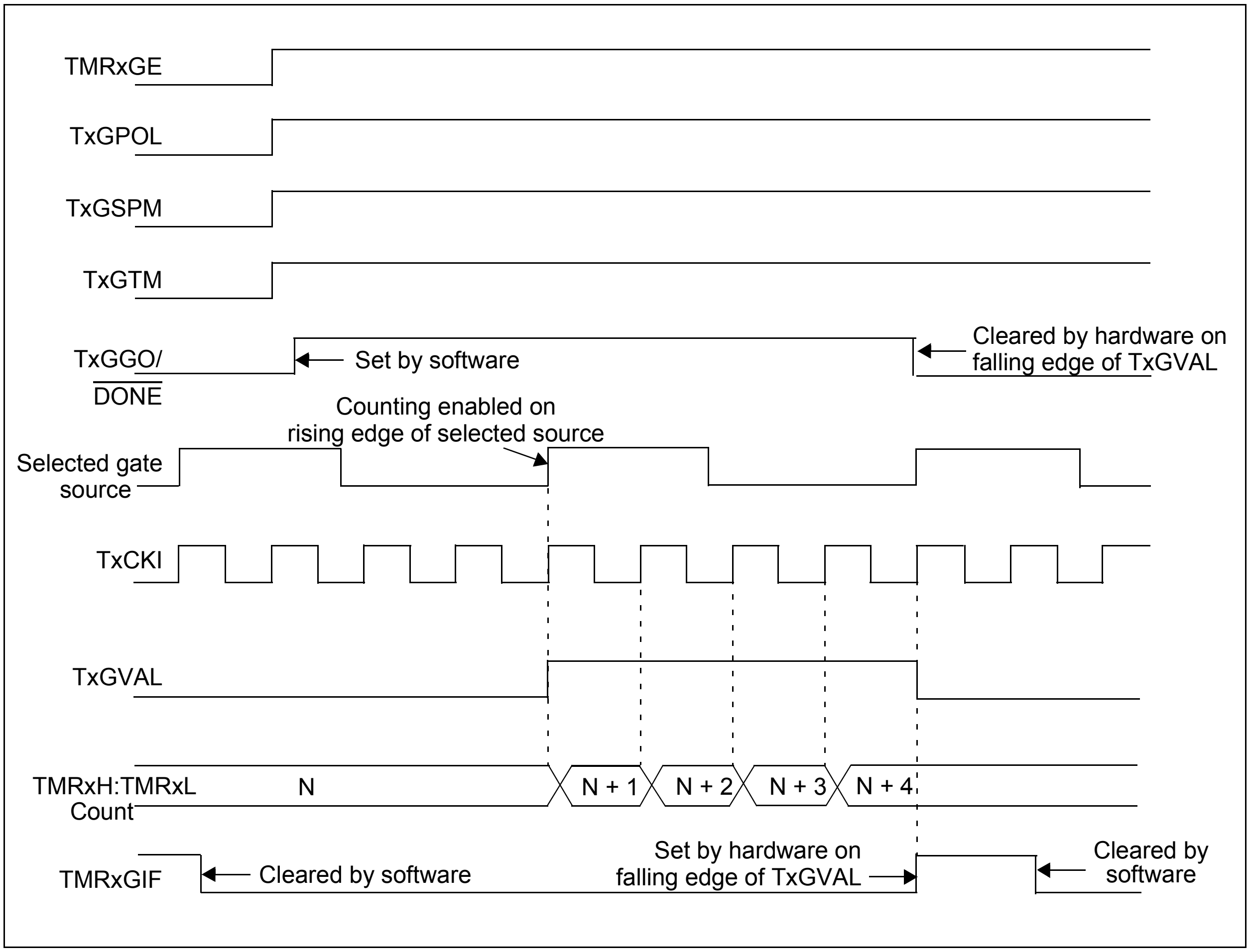
Note 1: Present only on the PIC16(L)F15345 20-pin devices.

FIGURE 23-2: COMPARATOR MODULE SIMPLIFIED BLOCK DIAGRAM



Note 1: When CxON = 0, all multiplexer inputs are disconnected and the Comparator will produce a '0' at the output.

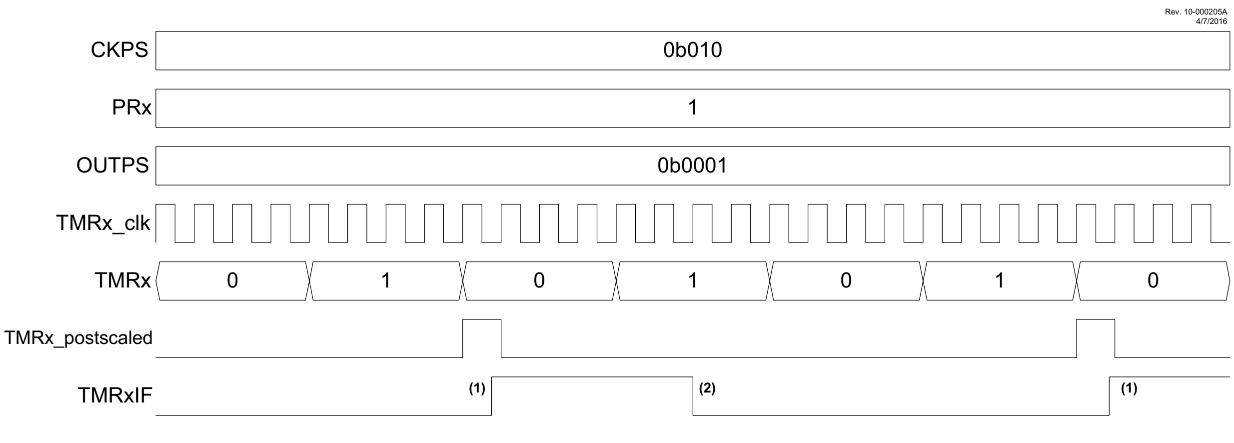
FIGURE 26-6: TIMER1 GATE SINGLE-PULSE AND TOGGLE COMBINED MODE



27.4 Timer2 Interrupt

Timer2 can also generate a device interrupt. The interrupt is generated when the postscaler counter matches one of 16 postscale options (from 1:1 through 1:16), which are selected with the postscaler control bits, OUTPS<3:0> of the T2CON register. The interrupt is enabled by setting the TMR2IE interrupt enable bit of the PIE4 register. Interrupt timing is illustrated in Figure 27-3.

FIGURE 27-3: TIMER2 PRESCALER, POSTSCALER, AND INTERRUPT TIMING DIAGRAM



Note 1: Setting the interrupt flag is synchronized with the instruction clock. Synchronization may take as many as 2 instruction cycles

2: Cleared by software.

28.0 CAPTURE/COMPARE/PWM MODULES

The Capture/Compare/PWM module is a peripheral that allows the user to time and control different events, and to generate Pulse-Width Modulation (PWM) signals. In Capture mode, the peripheral allows the timing of the duration of an event. The Compare mode allows the user to trigger an external event when a predetermined amount of time has expired. The PWM mode can generate Pulse-Width Modulated signals of varying frequency and duty cycle.

The Capture/Compare/PWM modules available are shown in Table 28-1.

TABLE 28-1: AVAILABLE CCP MODULES

Device	CCP1	CCP2
PIC16(L)F15325/45	●	●

The Capture and Compare functions are identical for all CCP modules.

> **Note 1:** In devices with more than one CCP module, it is very important to pay close attention to the register names used. A number placed after the module acronym is used to distinguish between separate modules. For example, the CCP1CON and CCP2CON control the same operational aspects of two completely different CCP modules.
>
> **2:** Throughout this section, generic references to a CCP module in any of its operating modes may be interpreted as being equally applicable to CCPx module. Register names, module signals, I/O pins, and bit names may use the generic designator ‘x’ to indicate the use of a numeral to distinguish a particular module, when required.

TABLE 29-3: SUMMARY OF REGISTERS ASSOCIATED WITH PWMx

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
T2CON	ON	CKPS<2:0>			OUTPS<3:0>				310
T2TMR	Holding Register for the 8-bit TMR2 Register								290*
T2PR	TMR2 Period Register								290*
RxyPPS	—	—	—	RxyPPS<4:0>					200
CWG1ISM	—	—	—	—	IS<3:0>				356
CLCxSELy	—	—	LCxDyS<5:0>						367
TRISA	—	—	TRISA5	TRISA4	—	TRISA2	TRISA1	TRISA0	178
TRISC	TRISC7(1)	TRISC6(1)	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	189

Legend: - = Unimplemented locations, read as ‘0’. Shaded cells are not used by the PWMx module.
* Page with Register information.

Note 1: Present on PIC16(L)F15345 only.

REGISTER 30-5: CWG1AS0: CWG1 AUTO-SHUTDOWN CONTROL REGISTER 0

R/W/HS-0/0	R/W-0/0	R/W-0/0	R/W-1/1	R/W-0/0	R/W-1/1	U-0	U-0
SHUTDOWN(1, 2)	REN	LSBD<1:0>		LSAC<1:0>		—	—
bit 7							bit 0

Legend:		
HC = Bit is cleared by hardware		HS = Bit is set by hardware
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7 **SHUTDOWN:** Auto-Shutdown Event Status bit(1, 2)
1 = An Auto-Shutdown state is in effect
0 = No Auto-shutdown event has occurred

bit 6 **REN:** Auto-Restart Enable bit
1 = Auto-restart enabled
0 = Auto-restart disabled

bit 5-4 **LSBD<1:0>:** CWG1B and CWG1D Auto-Shutdown State Control bits
11 =A logic ‘1’ is placed on CWG1B/D when an auto-shutdown event is present
10 =A logic ‘0’ is placed on CWG1B/D when an auto-shutdown event is present
01 =Pin is tri-stated on CWG1B/D when an auto-shutdown event is present
00 =The inactive state of the pin, including polarity, is placed on CWG1B/D after the required dead-band interval

bit 3-2 **LSAC<1:0>:** CWG1A and CWG1C Auto-Shutdown State Control bits
11 =A logic ‘1’ is placed on CWG1A/C when an auto-shutdown event is present
10 =A logic ‘0’ is placed on CWG1A/C when an auto-shutdown event is present
01 =Pin is tri-stated on CWG1A/C when an auto-shutdown event is present
00 =The inactive state of the pin, including polarity, is placed on CWG1A/C after the required dead-band interval

bit 1-0 **Unimplemented:** Read as ‘0’

Note 1: This bit may be written while EN = 0 (CWG1CON0 register) to place the outputs into the shutdown configuration.

2: The outputs will remain in auto-shutdown state until the next rising edge of the input signal after this bit is cleared.

REGISTER 30-6: CWG1AS1: CWG1 AUTO-SHUTDOWN CONTROL REGISTER 1

U-1	U-1	U-1	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	AS4E	AS3E	AS2E	AS1E	AS0E
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4 **AS4E:** CLC2 Output bit
1 = LC2_out shut-down is enabled
0 = LC2_out shut-down is disabled

bit 3 **AS3E:** Comparator C2 Output bit
1 = C2 output shut-down is enabled
0 = C2 output shut-down is disabled

bit 2 **AS2E:** Comparator C1 Output bit
1 = C1 output shut-down is enabled
0 = C1 output shut-down is disabled

bit 2 **AS1E:** TMR2 Postscale Output bit
1 = TMR2 Postscale shut-down is enabled
0 = TMR2 Postscale shut-down is disabled

bit 0 **AS0E:** CWG1 Input Pin bit
1 = Input pin selected by CWG1PPS shut-down is enabled
0 = Input pin selected by CWG1PPS shut-down is disabled

REGISTER 31-9: CLCxGLS2: GATE 2 LOGIC SELECT REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
LCxG3D4T	LCxG3D4N	LCxG3D3T	LCxG3D3N	LCxG3D2T	LCxG3D2N	LCxG3D1T	LCxG3D1N
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **LCxG3D4T:** Gate 2 Data 4 True (non-inverted) bit
1 = CLCIN3 (true) is gated into CLCx Gate 2
0 = CLCIN3 (true) is not gated into CLCx Gate 2

bit 6 **LCxG3D4N:** Gate 2 Data 4 Negated (inverted) bit
1 = CLCIN3 (inverted) is gated into CLCx Gate 2
0 = CLCIN3 (inverted) is not gated into CLCx Gate 2

bit 5 **LCxG3D3T:** Gate 2 Data 3 True (non-inverted) bit
1 = CLCIN2 (true) is gated into CLCx Gate 2
0 = CLCIN2 (true) is not gated into CLCx Gate 2

bit 4 **LCxG3D3N:** Gate 2 Data 3 Negated (inverted) bit
1 = CLCIN2 (inverted) is gated into CLCx Gate 2
0 = CLCIN2 (inverted) is not gated into CLCx Gate 2

bit 3 **LCxG3D2T:** Gate 2 Data 2 True (non-inverted) bit
1 = CLCIN1 (true) is gated into CLCx Gate 2
0 = CLCIN1 (true) is not gated into CLCx Gate 2

bit 2 **LCxG3D2N:** Gate 2 Data 2 Negated (inverted) bit
1 = CLCIN1 (inverted) is gated into CLCx Gate 2
0 = CLCIN1 (inverted) is not gated into CLCx Gate 2

bit 1 **LCxG3D1T:** Gate 2 Data 1 True (non-inverted) bit
1 = CLCIN0 (true) is gated into CLCx Gate 2
0 = CLCIN0 (true) is not gated into CLCx Gate 2

bit 0 **LCxG3D1N:** Gate 2 Data 1 Negated (inverted) bit
1 = CLCIN0 (inverted) is gated into CLCx Gate 2
0 = CLCIN0 (inverted) is not gated into CLCx Gate 2

TABLE 31-4: SUMMARY OF REGISTERS ASSOCIATED WITH CLCx (continued)

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	
CLC4GLS1	—	—	LC4G2D3T	LC4G2D3N	LC4G2D2T	LC4G2D2N	LC4G2D1T	LC4G2D1N	369
CLC4GLS2	—	—	LC4G3D3T	LC4G3D3N	LC4G3D2T	LC4G3D2N	LC4G3D1T	LC4G3D1N	370
CLC4GLS3	—	—	LC4G4D3T	LC4G4D3N	LC4G4D2T	LC4G4D2N	LC4G4D1T	LC4G4D1N	371
CLCIN0PPS	—	—	CLCIN0PPS<5:0>						199
CLCIN1PPS	—	—	CLCIN1PPS<5:0>						199
CLCIN2PPS	—	—	CLCIN2PPS<5:0>						199
CLCIN3PPS	—	—	CLCIN3PPS<5:0>						199

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the CLCx modules.

32.0 MASTER SYNCHRONOUS SERIAL PORT (MSSP1) MODULE

32.1 MSSP Module Overview

The Master Synchronous Serial Port (MSSP) module is a serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D converters, etc. The MSSP module can operate in one of two modes:

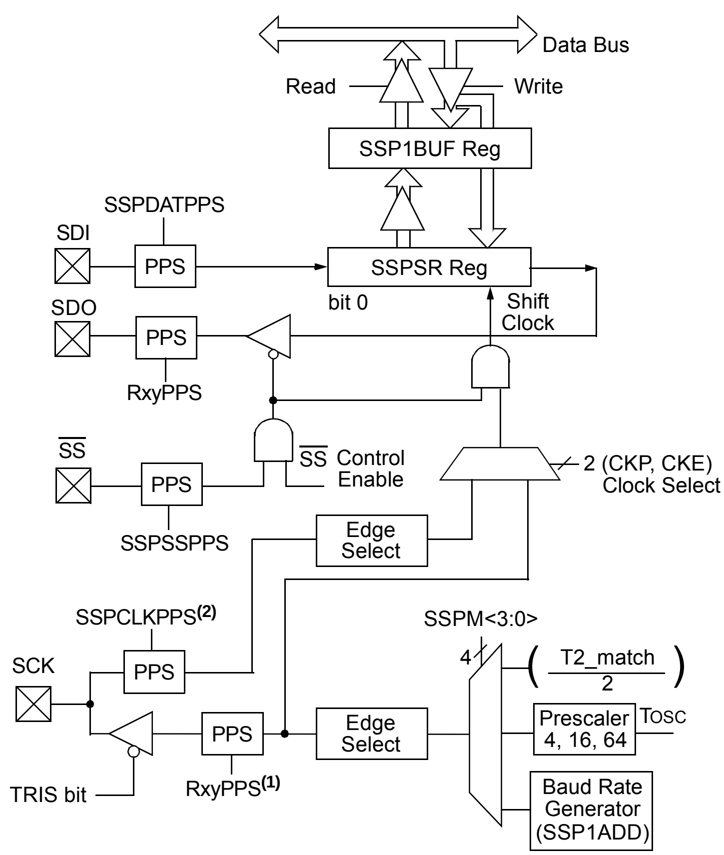
- Serial Peripheral Interface (SPI)
- Inter-Integrated Circuit (I^2C)

The SPI interface supports the following modes and features:

- Master mode
- Slave mode
- Clock Parity
- Slave Select Synchronization (Slave mode only)
- Daisy-chain connection of slave devices

Figure 32-1 is a block diagram of the SPI interface module.

FIGURE 32-1: MSSP BLOCK DIAGRAM (SPI MODE)



Note 1: Output selection for master mode.
2: Input selection for slave mode.

33.3 EUSART Baud Rate Generator (BRG)

The Baud Rate Generator (BRG) is an 8-bit or 16-bit timer that is dedicated to the support of both the asynchronous and synchronous EUSART operation. By default, the BRG operates in 8-bit mode. Setting the BRG16 bit of the BAUDxCON register selects 16-bit mode.

The SPxBRGH, SPxBRGL register pair determines the period of the free running baud rate timer. In Asynchronous mode the multiplier of the baud rate period is determined by both the BRGH bit of the TXxSTA register and the BRG16 bit of the BAUDxCON register. In Synchronous mode, the BRGH bit is ignored.

Table 33-1 contains the formulas for determining the baud rate. Example 33-1 provides a sample calculation for determining the baud rate and baud rate error.

Typical baud rates and error values for various Asynchronous modes have been computed for your convenience and are shown in Table 33-3. It may be advantageous to use the high baud rate (BRGH = 1), or the 16-bit BRG (BRG16 = 1) to reduce the baud rate error. The 16-bit BRG mode is used to achieve slow baud rates for fast oscillator frequencies.

Writing a new value to the SPxBRGH, SPxBRGL register pair causes the BRG timer to be reset (or cleared). This ensures that the BRG does not wait for a timer overflow before outputting the new baud rate.

If the system clock is changed during an active receive operation, a receive error or data loss may result. To avoid this problem, check the status of the RCIDL bit to make sure that the receive operation is idle before changing the system clock.

EXAMPLE 33-1: CALCULATING BAUD RATE ERROR

For a device with FOSC of 16 MHz, desired baud rate of 9600, Asynchronous mode, 8-bit BRG:

$$\text{Desired Baud Rate} = \frac{F_{OSC}}{64([SPBRGH:SPBRGL] + 1)}$$

Solving for SPxBRGH:SPxBRGL:

$$X = \frac{\frac{F_{OSC}}{\text{Desired Baud Rate}}}{64} - 1$$

$$= \frac{\frac{16000000}{9600}}{64} - 1$$

$$= [25.042] = 25$$

$$\text{Calculated Baud Rate} = \frac{16000000}{64(25 + 1)}$$

$$= 9615$$

$$\text{Error} = \frac{\text{Calc. Baud Rate} - \text{Desired Baud Rate}}{\text{Desired Baud Rate}}$$

$$= \frac{(9615 - 9600)}{9600} = 0.16\%$$

37.2 Standard Operating Conditions

The standard operating conditions for any device are defined as:

Operating Voltage: VDDMIN ≤ VDD ≤ VDDMAX
Operating Temperature: TA_MIN ≤ TA ≤ TA_MAX

VDD — Operating Supply Voltage[1]

PIC16LF15325/45

VDDMIN (Fosc ≤ 16 MHz) .... +1.8V
VDDMIN (Fosc ≤ 32 MHz) .... +2.5V
VDDMAX .... +3.6V

PIC16F15325/45

VDDMIN (Fosc ≤ 16 MHz) .... +2.3V
VDDMIN (Fosc ≤ 32 MHz) .... +2.5V
VDDMAX .... +5.5V

TA — Operating Ambient Temperature Range

Industrial Temperature

TA_MIN .... -40°C
TA_MAX .... +85°C

Extended Temperature

TA_MIN .... -40°C
TA_MAX .... +125°C

Note 1: See Parameter Supply Voltage, DS Characteristics: Supply Voltage.

TABLE 37-9: PLL SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated) VDD ≥ 2.5V							
Param. No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
PLL01	FPLLIN	PLL Input Frequency Range	4	—	8	MHz	
PLL02	FPLLOUT	PLL Output Frequency Range	16	—	32	MHz	**Note 1**
PLL03	TPLLST	PLL Lock Time from Start-up	—	200	—	μs	
PLL04	FPLLJIT	PLL Output Frequency Stability (Jitter)	-0.25	—	0.25	%	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The output frequency of the PLL must meet the FOSC requirements listed in Parameter D002.

FIGURE 37-7: CLKOUT AND I/O TIMING

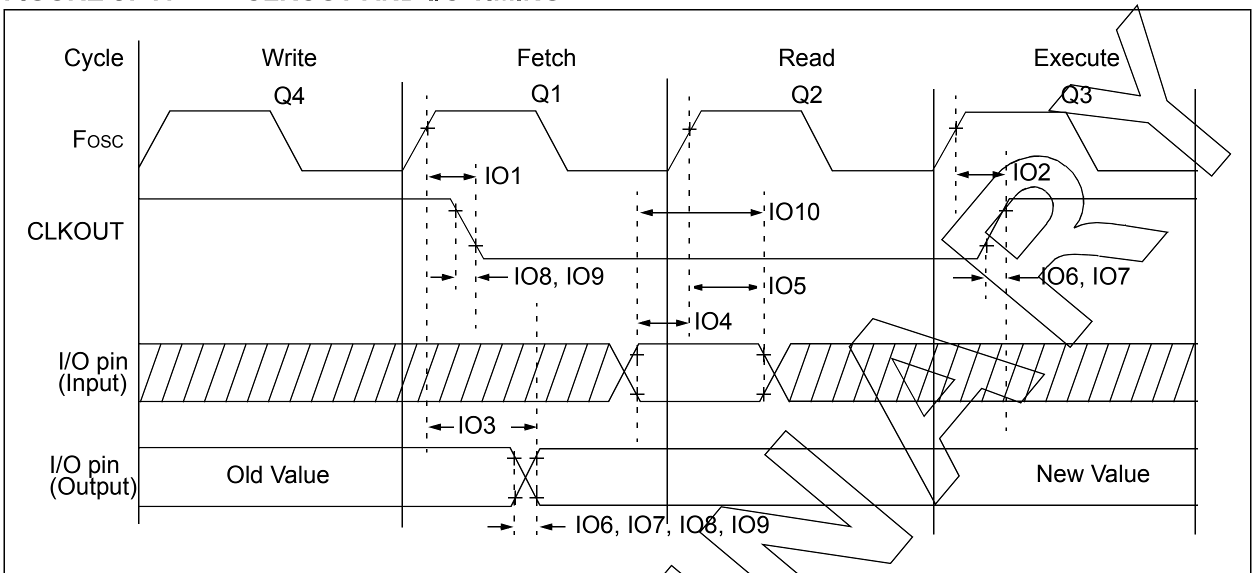


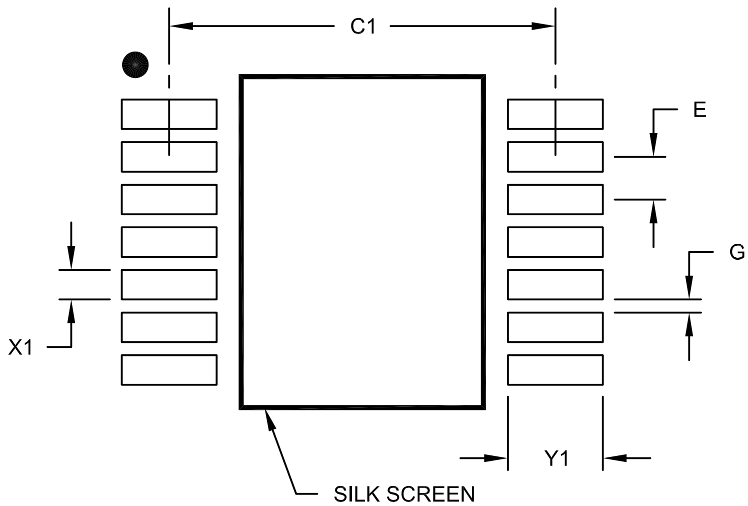
TABLE 37-10: I/O AND CLKOUT TIMING SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated)							
Param. No.	**Sym.**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
IO1*	$T_{CLKOUTH}$	CLKOUT rising edge delay (rising edge Fosc (Q1 cycle) to falling edge CLKOUT	—	—	70	ns	
IO2*	$T_{CLKOUTL}$	CLKOUT falling edge delay (rising edge Fosc (Q3 cycle) to rising edge CLKOUT	—	—	72	ns	
IO3*	T_{IO_VALID}	Port output valid time (rising edge Fosc (Q1 cycle) to port valid)	—	50	70	ns	
IO4*	T_{IO_SETUP}	Port input setup time (Setup time before rising edge Fosc – Q2 cycle)	20	—	—	ns	
IO5*	T_{IO_HOLD}	Port input hold time (Hold time after rising edge Fosc – Q2 cycle)	50	—	—	ns	
IO6*	T_{IOR_SLREN}	Port I/O rise time, slew rate enabled	—	25	—	ns	VDD = 3.0V
IO7*	T_{IOR_SLRDIS}	Port I/O rise time, slew rate disabled	—	5	—	ns	VDD = 3.0V
IO8*	T_{IOF_SLREN}	Port I/O fall time, slew rate enabled	—	25	—	ns	VDD = 3.0V
IO9*	T_{IOF_SLRDIS}	Port I/O fall time, slew rate disabled	—	5	—	ns	VDD = 3.0V
IO10*	T_{INT}	INT pin high or low time to trigger an interrupt	25	—	—	ns	
IO11*	T_{IOC}	Interrupt-on-Change minimum high or low time to trigger interrupt	25	—	—	ns	

*These parameters are characterized but not tested.

14-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	C1		5.90	
Contact Pad Width (X14)	X1			0.45
Contact Pad Length (X14)	Y1			1.45
Distance Between Pads	G	0.20		

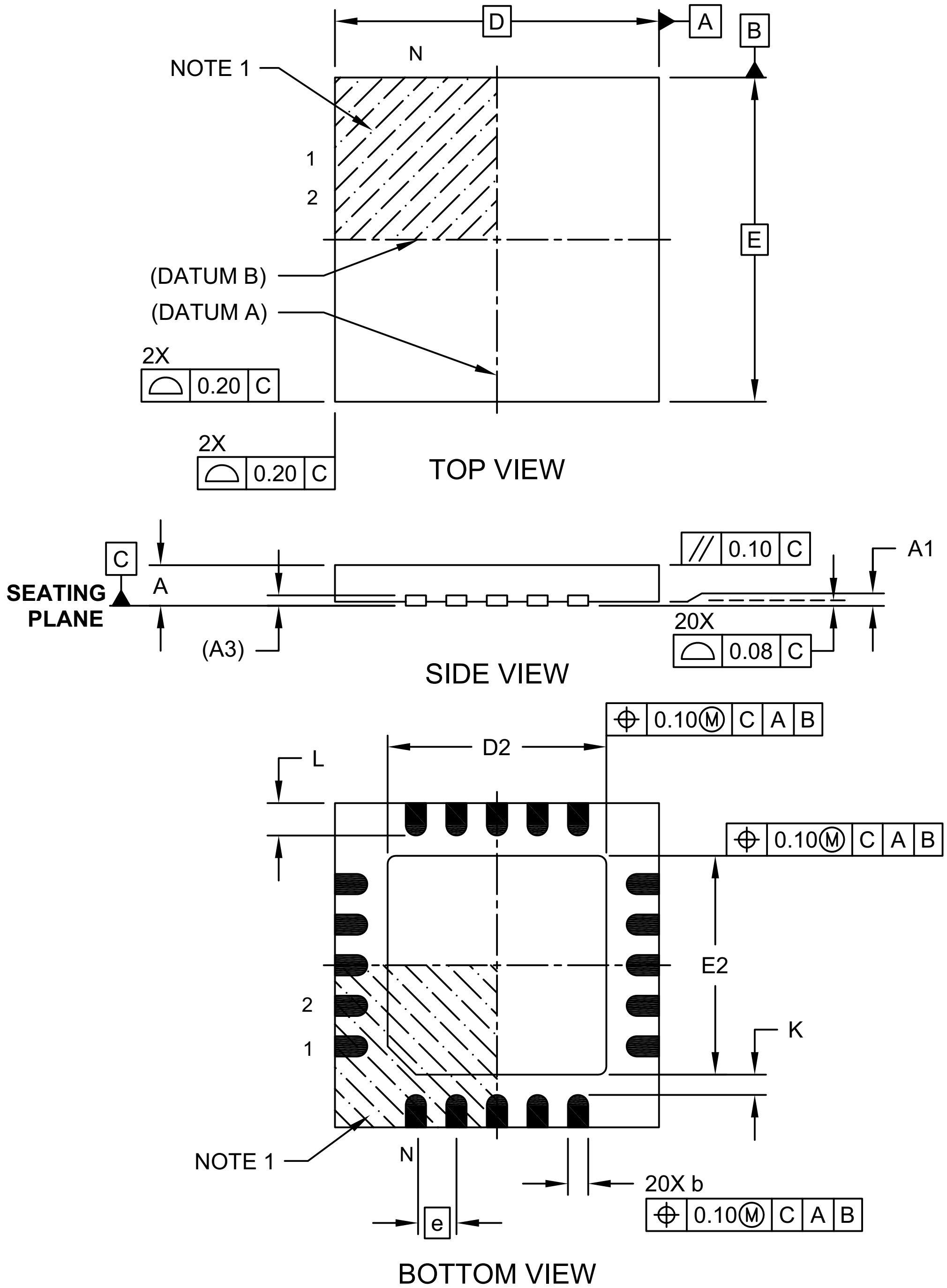
Notes:

1. Dimensioning and tolerancing per ASME Y14.5M
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2087A

20-Lead Ultra Thin Plastic Quad Flat, No Lead Package (GZ) - 4x4x0.5 mm Body [UQFN]

Note:	For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-255A Sheet 1 of 2